

Liquid Cooling Guidelines

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ASHRAE Overview

- 1. ASHRAE (American Society of Heating Refrigerating, & Air conditioning Engineering) formed in **1894** is a technical society; specializing in cooling.
- 2. ASHRAE has over **50,000** members & has members in 135 countries
- 3. ASHRAE focuses on maintaining an unbiased role within the industry
- 4. ASHRAE actively writes standards, guidelines, model codes, etc.



ASHRAE and Datacenters

- ASHRAE American Society of Heating, Refrigeration and Air-conditioning Engineers
- •Technical Committee 9.9 Mission Critical Facilities, Technology Spaces and Electronic Equipment
 - Datacom Equipment producers, (manufacturers of computer hardware, HVAC equipment, software vendors, etc)
 - User of Datacom Equipment (facility owners, operators, managers, etc)
 - General Interest

(government agencies, utilities, consultants, academia, testing laboratories, etc.)

 Mission Statement: To be recognized by ALL areas of the datacom industry as the <u>unbiased engineering leader in HVAC</u> and an effective provider of technical information for the datacom industry.



Thermal Guidelines for Data Processing Environments

Structural and Vibration Guidelines for Datacom Equipment Centers

ASHRAE Datacom Series

ASHRAE Datacom Book Series Datacom Equipment Power Trends and Cooling Applications

> Design Considerations for Datacom Equipment Cen

> > ac

Best Practices for Datacom Facility Energy Efficiency

ASHRAE Datacom Series

Liquid Cooling Design Considerations for Data and Communications Equipment Centers

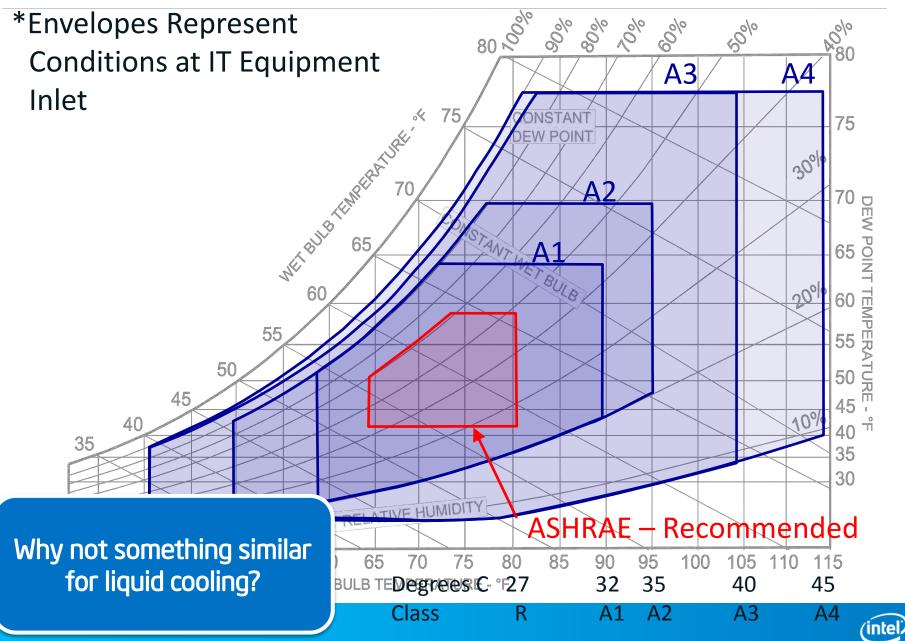
> High Density Data Center: Case Studies and Other Considerations

> > ASHRAE Datacom Series

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2011 ASHRAE Air-Cooled Thermal Guidelines



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ASHRAE TC 9.9

2011 Thermal Guidelines for Liquid Cooled Data Processing Environments

Whitepaper prepared by ASHRAE Technical Committee (TC) 9.9 Mission Critical Facilities, Technology Spaces, and Electronic Equipment

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2006 book now supplemented by 2011 WP

Liquid Cooling Design Considerations for Data and Communications Equipment Centers

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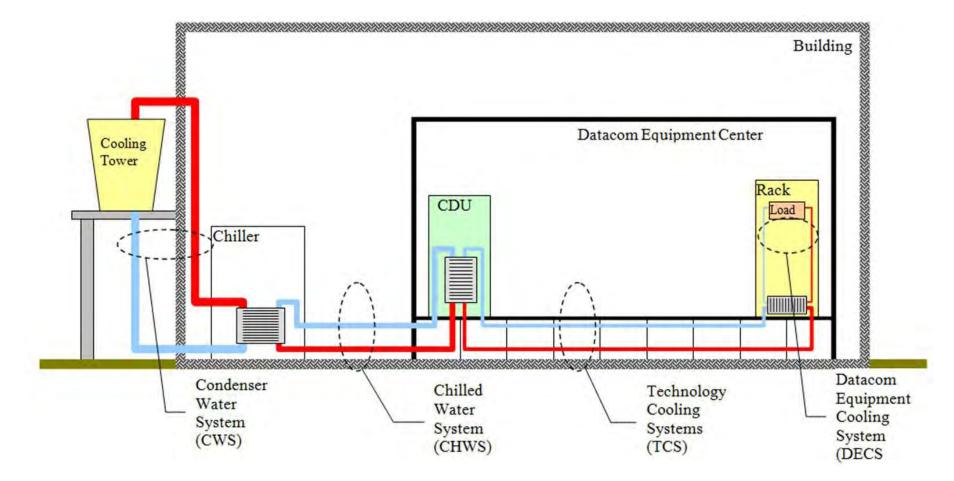
2011 ASHRAE Liquid Cooling Guidelines

- Drivers for More Detailed Liquid Guidelines <u>Improve and Increase Liquid</u> <u>Cooling Use and Reduce Confusion among users and suppliers</u>
- HPC Challenges with more and more power per node and per rack, pushing to and past air-cooling limits
- Range of cooling architectures not well aligned to IT requirements
- ASHRAE TC 9.9 Response <u>Enable Opportunity for Innovation</u>
- Defined liquid cooling classes with temperature ranges
- Created guidance to effectively implement liquid cooling through new White Paper
- ASHRAE TC 9.9 IT Subcommittee: Bull, Cisco, Cray, Dell, EMC, Fujitsu, HP, IBM, Intel, Juniper, Lucent, Nortel Networks, Oracle/Sun, Seagate, SGI, Teradata

Cross HPC-IT Team collaboratively authors WP on liquid cooling



What is liquid cooling? Which liquid are we talking about?





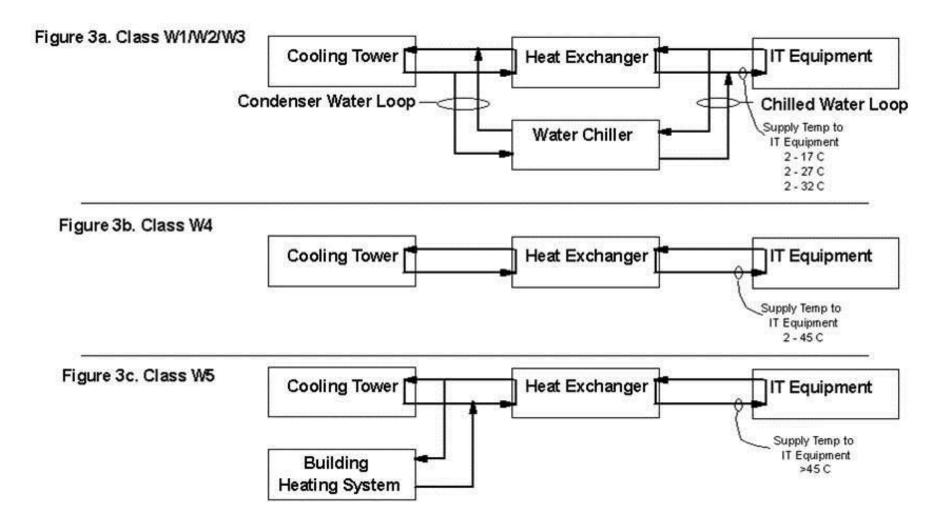
2011 ASHRAE Liquid-Cooled Thermal Guidelines

Classes	Typical Infrastructure Design				
	Main Cooling Equipment	Supplemental Cooling Equipment	Facility Supply Water Temp (C)	IT Equipment Availability	
W1		Water-side	2 – 17		
W2	Chiller/Cooling Tower	Economizer Chiller	2 – 27	Now available	
W3	Cooling Tower	Chiller	2 – 32	Not generally available, dependent on future demand	
W4	Water-side Economizer (with drycooler or cooling tower)	Nothing	2 – 45		
W5	Building Heating System	Cooling Tower	> 45	Specialized systems	

Required Cooling Infrastructure: Balance of Silicon/Datacenter



ASHRAE Classes





More from the White Paper

Operational Considerations

- Condensation
- Flow and differential pressure limits
- Class specific limits

Water flow rates vs capacity

Velocity LimitsBy size / material

System Design

- Materials
- Connections
- Heat Rejection devices

Water Quality

- Corrosion
- Fouling
- Scaling
- Micro

Bibliography



As advertised earlier... don't miss these

Birds of Feather: "Hot' for Warm Water Cooling"

• Tuesday, 5:30-7:00PM WSCC 613/614

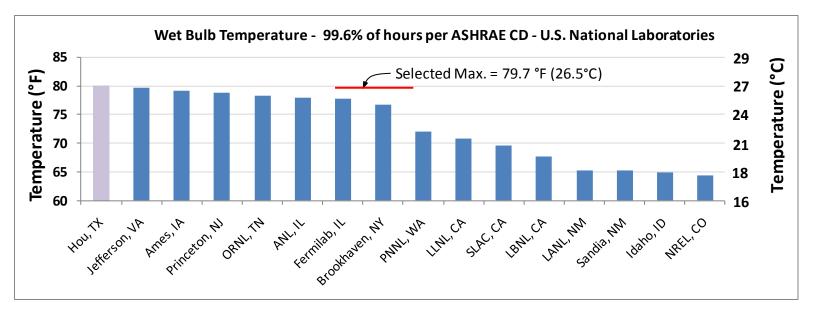
State of the Practice: "Hot' for Warm Water Cooling"

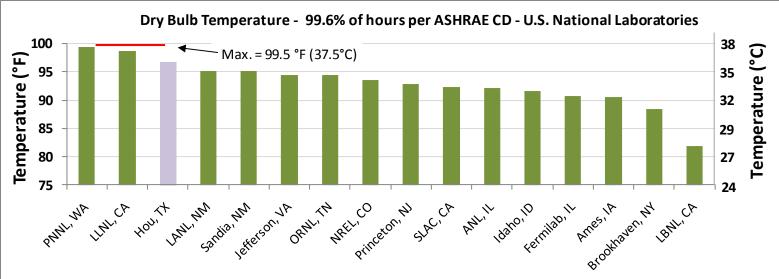
• Wednesday, 4:00-4:30PM TC 202



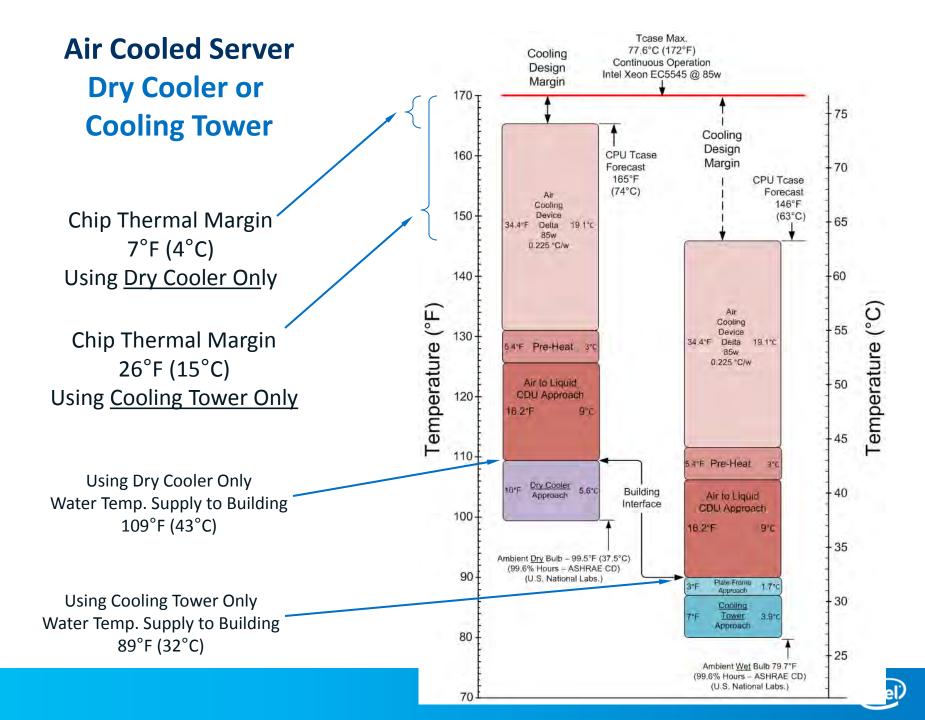
Wet and Dry Bulb Temperatures

ASHRAE CD, 99.6% of yearly hours, National Laboratory HPC Locations.









Infrastructure In

IT Out

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Two liquid cooling activities meeting in the middle

	EEHPCWG		ASHRAE	
L1	17 °C	Legacy systems w/ chiller	2-17 °C	W1
		Cooling tower & Chiller based Rack level cooling	2-27 °C	W2
L2	32 °C	Cooling tower & Chiller based Rack/Component level cooling	2-32 °C	W3
L3	43 °C	Dry cooler based Component level cooling	2-45 °C	W4
		Heat re-use opportunity Component level cooling	>45 °C	W5

Thank You!

Questions?





